

RoHS Compliant Product  
A suffix of "-C" specifies halogen and lead-free

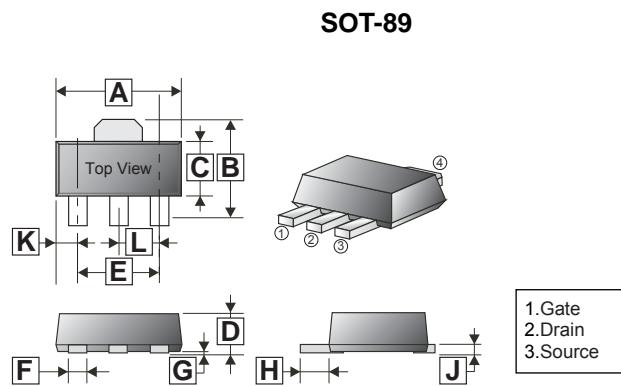
## DESCRIPTION

The SGM2310B utilized advanced processing techniques to achieve the lowest possible on-resistance, extremely efficient and cost-effectiveness device. The SGM2310B is universally used for all commercial-industrial applications.

## FEATURES

- Simple Drive Requirement
- Small Package Outline

## MARKING

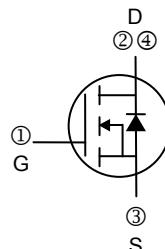


| REF. | Millimeter |      | REF. | Millimeter |      |
|------|------------|------|------|------------|------|
|      | Min.       | Max. |      | Min.       | Max. |
| A    | 4.40       | 4.60 | G    | -          | -    |
| B    | 4.05       | 4.25 | H    | 0.89       | 1.20 |
| C    | 2.40       | 2.60 | J    | 0.35       | 0.41 |
| D    | 1.40       | 1.60 | K    | 0.70       | 0.80 |
| E    | 3.00 REF.  |      | L    | 1.50 REF.  |      |
| F    | 0.40       | 0.52 |      |            |      |

## PACKAGE INFORMATION

| Package | MPQ | Leader Size |
|---------|-----|-------------|
| SOT-89  | 3K  | 7 inch      |

## TOP VIEW



## ABSOLUTE MAXIMUM RATINGS ( $T_A=25^\circ\text{C}$ unless otherwise specified)

| Parameter   | Symbol          | Ratings  | Unit                        |
|---|-----------------|----------|-----------------------------|
| Drain-Source Voltage  | $V_{DS}$        | 60       | V                           |
| Gate-Source Voltage   | $V_{GS}$        | $\pm 20$ | V                           |
| Continuous Drain Current <sup>1</sup> , $V_{GS}@10\text{V}$ | $I_D$           | 2.7      | A                           |
| $T_A=70^\circ\text{C}$                                      |                 | 2.2      |                             |
| Pulsed Drain Current <sup>2</sup>                           | $I_{DM}$        | 10       | A                           |
| Power Dissipation <sup>3</sup>                              | $P_D$           | 1.25     | W                           |
| Linear Derating Factor                                      |                 | 0.01     | $^\circ\text{C} / \text{W}$ |
| Operating Junction and Storage Temperature Range            | $T_j, T_{stg}$  | -55~150  | $^\circ\text{C}$            |
| Thermal Resistance Rating                                   |                 |          |                             |
| Maximum Junction to Ambient <sup>1</sup>                    | $R_{\theta JA}$ | 100      | $^\circ\text{C} / \text{W}$ |

**ELECTRICAL CHARACTERISTICS** ( $T_A=25^\circ C$  unless otherwise specified)

| Parameter                                | Symbol       | Min. | Typ. | Max.      | Unit      | Test Conditions   |
|--|--------------|------|------|-----------|-----------|---|
| <b>Static</b>                            |              |      |      |           |           |   |
| Drain-Source Breakdown Voltage           | $BV_{DSS}$   | 60   | -    | -         | V         | $V_{GS}=0$ , $I_D=250\mu A$                                       |
| Gate-Threshold Voltage                   | $V_{GS(th)}$ | 1    | -    | 2.5       | V         | $V_{DS}=V_{GS}$ , $I_D=250\mu A$                                  |
| Forward Transconductance                 | $g_{fs}$     | -    | 13   | -         | S         | $V_{DS}=5V$ , $I_D=2A$  |
| Gate-Body Leakage Current                | $I_{GSS}$    | -    | -    | $\pm 100$ | nA        | $V_{GS}=\pm 20V$  |
| Drain-Source Leakage Current             | $I_{DSS}$    | -    | -    | 1         | $\mu A$   | $V_{DS}=48V$ , $V_{GS}=0$   |
|  |              | -    | -    | 5         |           | $V_{DS}=48V$ , $V_{GS}=0$   |
| Drain-Source On-Resistance <sup>2</sup>  | $R_{DS(ON)}$ | -    | -    | 100       | $m\Omega$ | $V_{GS}=10V$ , $I_D=2.5A$   |
|  |              | -    | -    | 110       |           | $V_{GS}=4.5V$ , $I_D=1.5A$  |
| Total Gate Charge                        | $Q_g$        | -    | 5    | -         | nC        | $V_{DS}=48V$ ,<br>$V_{GS}=4.5V$ ,<br>$I_D=2A$                     |
| Gate-Source Charge                       | $Q_{gs}$     | -    | 1.68 | -         |           |   |
| Gate-Drain ("Miller") Charge             | $Q_{gd}$     | -    | 1.9  | -         |           |   |
| Turn-on Delay Time <sup>2</sup>          | $T_{d(on)}$  | -    | 1.6  | -         | nS        | $V_{DD}=30V$ ,<br>$V_{GS}=10V$ ,<br>$R_G=3.3\Omega$ ,<br>$I_D=2A$ |
| Rise Time                                | $T_r$        | -    | 7.2  | -         |           |   |
| Turn-off Delay Time                      | $T_{d(off)}$ | -    | 25   | -         |           |   |
| Fall Time                                | $T_f$        | -    | 14.4 | -         |           |   |
| Input Capacitance                        | $C_{iss}$    | -    | 511  | -         | pF        | $V_{GS}=0$ ,<br>$V_{DS}=15V$ ,<br>$f=1.0MHz$                      |
| Output Capacitance                       | $C_{oss}$    | -    | 38   | -         |           |   |
| Reverse Transfer Capacitance             | $C_{rss}$    | -    | 25   | -         |           |   |
| <b>Source-Drain Diode</b>                |              |      |      |           |           |   |
| Diode Forward Voltage <sup>2</sup>       | $V_{SD}$     | -    | -    | 1.2       | V         | $I_S=1A$ , $V_{GS}=0$   |
| Continuous Source Current <sup>1,4</sup> | $I_S$        | -    | -    | 2.7       | A         | $V_G=V_D=0$ , Force Current                                       |
| Pulsed Source Current <sup>2,4</sup>     | $I_{SM}$     | -    | -    | 10        |           |   |
| Reverse Recovery Time                    | $T_{RR}$     | -    | 9.7  | -         | nS        | $I_S=2A$ , $dI/dt=100A/\mu s$                                     |
| Reverse Recovery Charge                  | $Q_{RR}$     | -    | 5.8  | -         | nC        | $V_{GS}=0$  |

Notes:

1. Surface mounted on FR4 board ,  $t \leq 10sec$ .
2. The data tested by pulsed , pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$
3. The power dissipation is limited by  $150^\circ C$  junction temperature
4. The data is theoretically the same as  $I_D$  and  $I_{DM}$  , in real applications , should be limited by total power dissipation

## CHARACTERISTIC CURVES

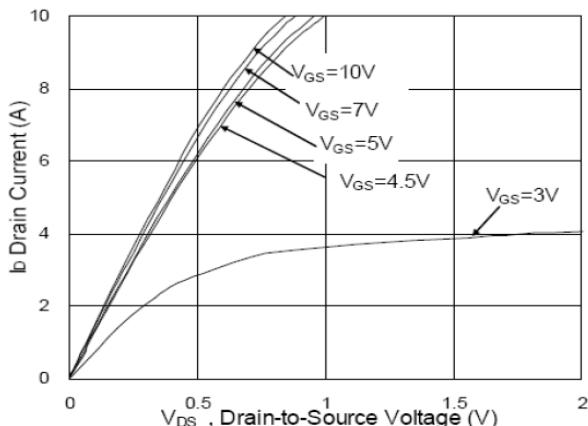


Fig.1 Typical Output Characteristics

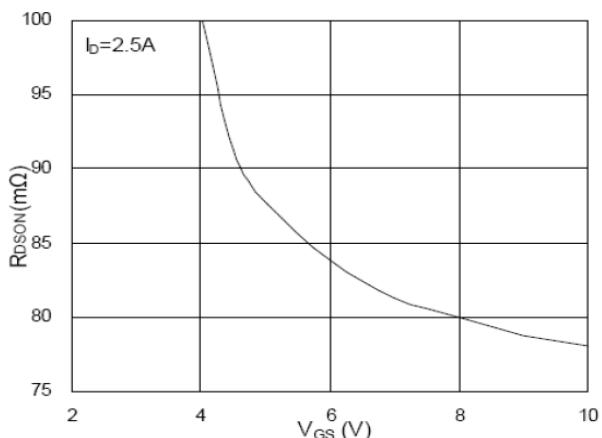


Fig.2 On-Resistance v.s Gate-Source

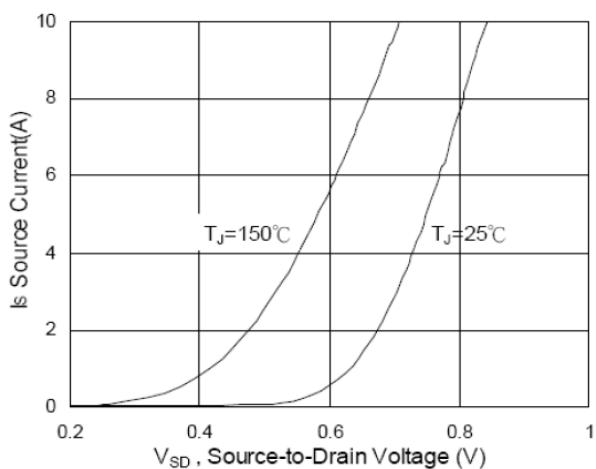


Fig.3 Forward Characteristics of Reverse

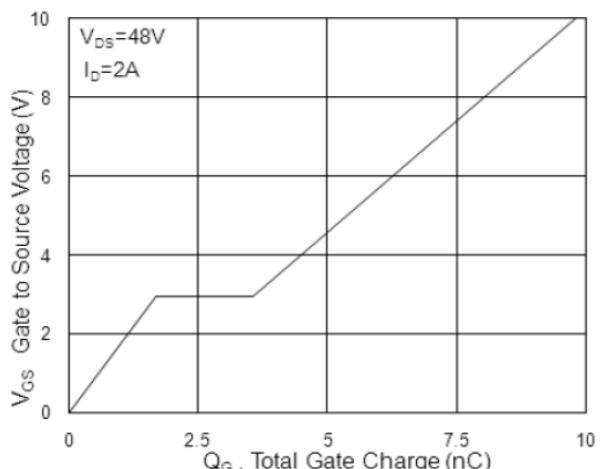


Fig.4 Gate-Charge Characteristics

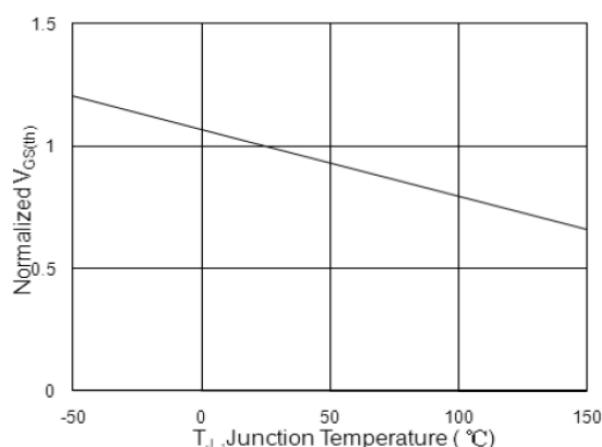


Fig.5 Normalized  $V_{GS(th)}$  v.s  $T_J$

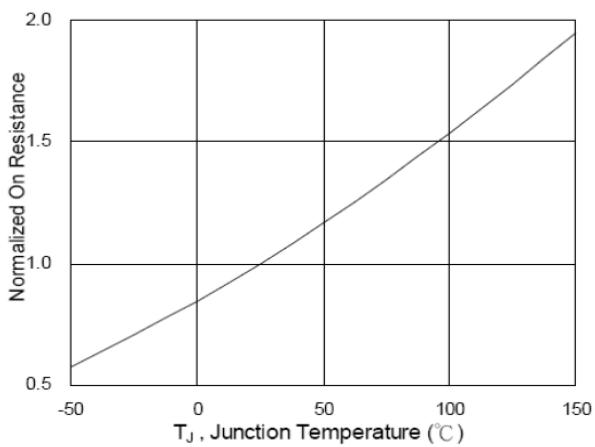


Fig.6 Normalized  $R_{DS(on)}$  v.s  $T_J$

## CHARACTERISTIC CURVES

